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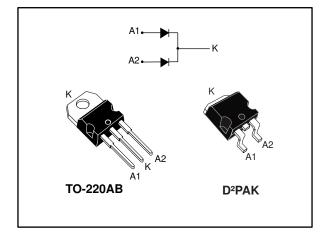




FERD30L60C

60 V field-effect rectifier diode

Datasheet - production data



Features

- ST advanced rectifier process
- Stable leakage current over reverse voltage
- Reduced leakage current
- Low forward voltage drop
- High frequency operation

Description

The device is based on a proprietary technology that achieves the best in class $V_{\text{F}}/I_{\text{R}}$ trade-off for a given silicon surface.

This 60 V rectifier has been optimized for use in confined applications where both efficiency and thermal performance are key.

This device is suitable for use in adapters and chargers.

	Table ⁻	1:	Device	summary
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Symbol	Value
I _{F(AV)}	2 x 15 A
V _{RRM}	60 V
V _F (typ.)	0.37 V
T _j (max.)	150 °C

September 2017

DocID030960 Rev 1

This is information on a product in full production.

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, per diode, unless otherwise specified)

Symbol	Parameter	Value	Unit		
VRRM	Repetitive peak reverse voltage		60	V	
I _{F(RMS)}	Forward rms current			60	А
	Average forward current δ = 0.5,	T 100.00	Per diode	15	
lf(AV)	square wave	T _c = 130 °C Per device		30	А
IFSM	Surge non repetitive forward current	250	А		
T _{stg}	Storage temperature range		-65 to +175	°C	
Tj	Maximum operating junction temperature		+150	°C	

Notes:

 $^{(1)}(dP_{tot}/dT_j) < (1/R_{th(j\text{-}a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Symbol	Parameter	Max. value	Unit	
Р	lunction to page	Per diode	1.5	
R _{th(j-c)}	Junction to case	Total	0.9	°C/W
Rth(c)	Coupling		0.3	

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
		T _j = 25 °C	V _B = V _{BBM}	-		820	μA
I _R ⁽¹⁾	Reverse leakage current	T _j = 125 °C	$\mathbf{v}_{\mathrm{R}} = \mathbf{v}_{\mathrm{RRM}}$	-	30	60	
		T _j = 125 °C	$V_R = 45 V$	-	17	34	mA
VF ⁽²⁾ Forward voltage d		T _j = 25 °C	IF = 3 A	-	0.32	0.36	V
	Forward voltage drop	T _j = 125 °C		-	0.26	0.30	
		T _j = 25 °C	I _F = 7.5 A	-	0.39	0.435	
		T _j = 125 °C		-	0.37	0.42	
		T _j = 25 °C	I _F = 15 A	-	0.49	0.545	
		T _j = 125 °C		-	0.51	0.57	

Notes:

$$\label{eq:powerset} \begin{split} ^{(1)} \mbox{Pulse test: } t_p = 5 \mbox{ ms, } \delta < 2\% \\ ^{(2)} \mbox{Pulse test: } t_p = 380 \mbox{ µs, } \delta < 2\% \end{split}$$

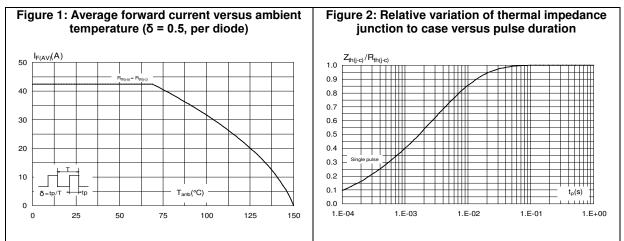
To evaluate the conduction losses use the following equation:

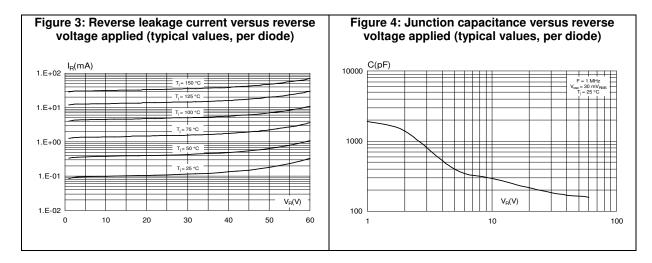
 $P = 0.27 \ x \ I_{F(AV)} + 0.02 \ x \ I_{F^2(RMS)}$

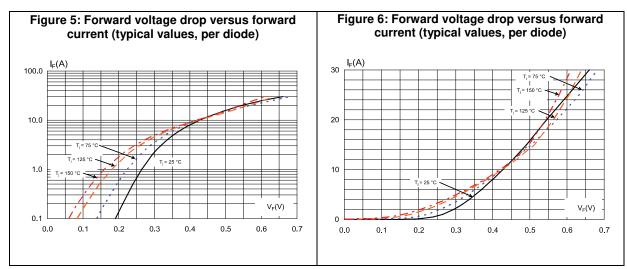


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1.1 Characteristics (curves)





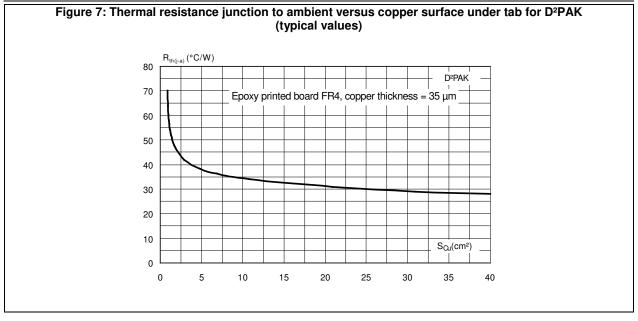


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Characteristics

FERD30L60C





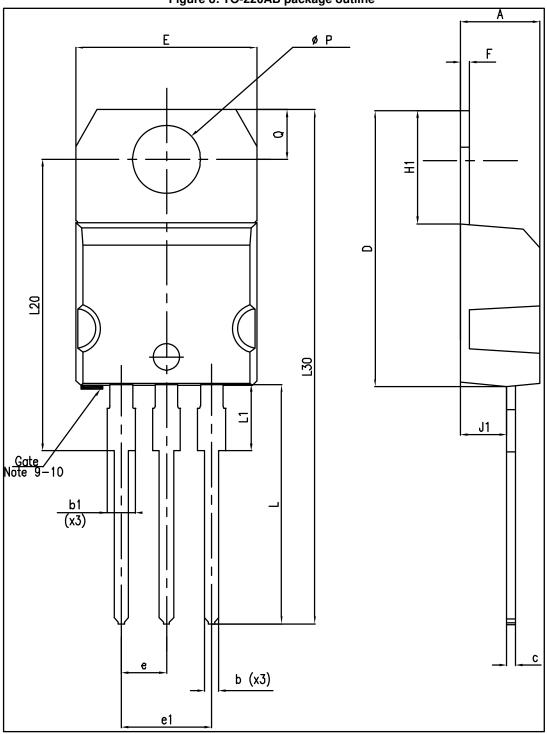
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL94,V0
- Recommended torque value: 0.55 N·m (for TO-220AB)
- Maximum torque value: 0.6 N·m (for TO-220AB)









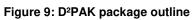
FERD30L60C

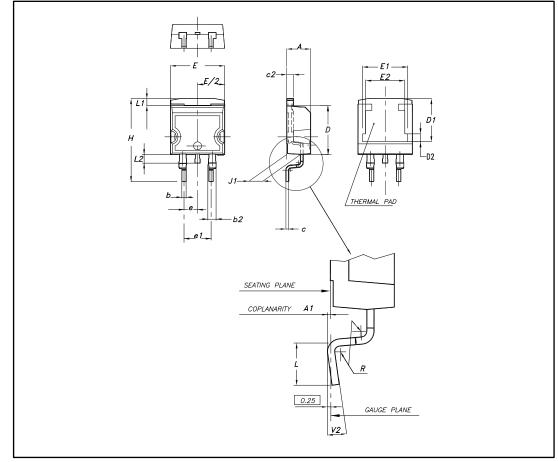
Package information

0C			Pa	ckage information		
Table 5: TO-220AB package mechanical data						
		Dimer	nsions			
Ref.	Millim	neters	Incl	nes		
	Min.	Max.	Min.	Max.		
A	4.40	4.60	0.173	0.181		
b	0.61	0.88	0.024	0.035		
b1	1.14	1.70	0.045	0.067		
С	0.48	0.70	0.019	0.028		
D	15.25	15.75	0.600	0.620		
E	10.00	10.40	0.394	0.409		
е	2.40	2.70	0.094	0.106		
e1	4.95	5.15	0.195	0.203		
F	0.51	0.60	0.020	0.024		
J1	2.40	2.72	0.094	0.107		
H1	6.20	6.60	0.244	0.256		
L	13.00	14.00	0.512	0.551		
L1	3.50	3.93	0.138	0.155		
L20	16.40	D typ.	0.646	δ typ.		
L30	28.90) typ.	1.1	38		
Ø P	3.75	3.85	0.148	0.156		
Q	2.65	2.95	0.104	0.116		









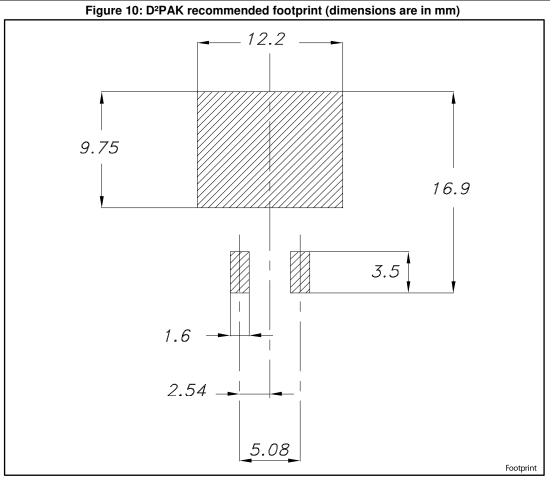


FERD30L60C

Package information

50C					Packag	e information	
	Table 6: D ² PAK package mechanical data						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	4.40		4.60	0.173		0.181	
A1	0.03		0.23	0.001		0.009	
b	0.70		0.93	0.028		0.037	
b2	1.14		1.70	0.045		0.067	
С	0.45		0.60	0.018		0.024	
c2	1.23		1.36	0.048		0.053	
D	8.95		9.35	0.352		0.368	
D1	7.50	7.75	8.00	0.295	0.305	0.315	
D2	1.10	1.30	1.50	0.043	0.051	0.060	
E	10		10.40	0.394		0.409	
E1	8.50	8.70	8.90	0.335	0.343	0.346	
E2	6.85	7.05	7.25	0.266	0.278	0.282	
е		2.54			0.100		
e1	4.88		5.28	0.190		0.205	
Н	15		15.85	0.591		0.624	
J1	2.49		2.69	0.097		0.106	
L	2.29		2.79	0.090		0.110	
L1	1.27		1.40	0.049		0.055	
L2	1.30		1.75	0.050		0.069	
R		0.4			0.015		
V2	0°		8°	0°		8°	





3 Ordering information

Table 7: Ordering information					
Order code	Marking	Package	Weight	Base qty.	Delivery mode
FERD30L60CTS	FD30L60CTS	TO-220AB	1.38 g	50	Tube
FERD30L60CG-TR	FD30L60CG	D ² PAK	1.43 g	1000	Tape and reel

4 Revision history

Table 8: Document revision history

Date	Revision	Changes
01-Sep-2017	1	Initial release.



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